

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Jiann T'suen Lin</td> <td>12/01/2008</td> </tr> <tr> <td>Mei-Yi Lai</td> <td>12/01/2008</td> </tr> <tr> <td>Chih-Hsin Chen</td> <td>12/01/2008</td> </tr> </tbody> </table>		Name	Execution Date	Jiann T'suen Lin	12/01/2008	Mei-Yi Lai	12/01/2008	Chih-Hsin Chen	12/01/2008
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Jiann T'suen Lin	12/01/2008								
Mei-Yi Lai	12/01/2008								
Chih-Hsin Chen	12/01/2008								
RECEIVING PARTY DATA									
Name:	Academia Sinica								
Street Address:	128 Sec. 2, Academia Road								
City:	Nankang Teipei								
State/Country:	TAIWAN								
Postal Code:	11529								
PROPERTY NUMBERS Total: 1									
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12270918</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12270918				
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Application Number:	12270918								
CORRESPONDENCE DATA									
Fax Number:	(212)972-5487								
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
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NAME OF SUBMITTER:	Kent H. Cheng								

CH \$40.00 12270918

Total Attachments: 3
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ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, We the undersigned, **Jiann T'suen LIN, Mei-Yi LAI, Chih-Hsin CHEN** (hereinafter referred to as "ASSIGNOR"):

Hereby sell, assign and transfer to **Academia Sinica**, (hereinafter referred to as "ASSIGNEE"), a corporation of Taiwan, having a place of business at 128 Sec. 2, Academia Road, 11529 Nankang Teipei, Taiwan; respectively, its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to the invention which is disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith, and which is entitled

MATERIALS FOR ORGANIC LIGHT-EMITTING DIODES

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on said invention; and in and to all original, reissued and other patents and certificates of invention which have been or shall be issued in the United States and all foreign countries on said invention;

Agree that said Assignee may apply for and receive Letters Patent for said invention in its own name, and that, when requested, without further consideration from or charge to, but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on said invention; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee,

its successors, assigns, and representatives, all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said invention and for vesting title to said invention and all applications for patents and all patents on said invention, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 12/01/2008
month/day/year

Jiann Tsuen Lin
Jiann T'suen LIN

Yung-Sheng Yen
Witness

Ying-Chan Hsu
Witness

Date: 12/01/2008
month/day/year

Mei-Yi Lai
Mei-Yi LAI

Yung-Sheng Yen
Witness

Ying-Chan Hsu
Witness

Date: 12/01/2008
month/day/year

Chih-Hsin Chen
Chih-Hsin CHEN

Yung-Sheng Yen
Witness

Ying-Chan Hsu
Witness